

N-Channel 40V MOSFET

Product summary

V _{DS} (V)	$R_{DS(on),max}$ (m Ω)	I _D (A)		
40	1.1 @ V _{GS} = 10V	240 ⁽¹⁾		

Features

- Low RDS(on) trench technology
- Low thermal impedance
- Fast switching speed
- 100% avalanche tested

Applications

- DC/DC conversion
- Power switch
- Motor drives

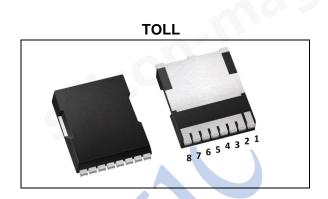
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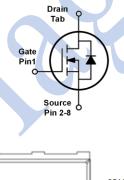
Package and ordering information

Ordering code	Package	Device code
SDH04L1P0T-AA	TOLL-8L	AGQ

Maximum ratings 1.

Absolute maximum ratings ($T_A = 25^{\circ}C$ unless otherwise noted)				
Parameter			Limit	Unit
Drain-source voltage			40	V
Gate-source voltage			±20	V
	Tc=25°C ⁽¹⁾		240	A
Continuous drain current	Tc=100°C	I _D	192	
	T _A =25°C ⁽⁴⁾		41	
Pulsed drain current ⁽²⁾	I _{D,pulse}	960		
Avalanche energy, single pulse ⁽³⁾			417	mJ
Power dissipation $\begin{tabular}{c} $T_c=25^{\circ}C$ \\ $T_A=25^{\circ}C$ \end{tabular}^{(4)} \end{tabular}$		- P _D	167	W
		' D	3.1	
Operating junction and storage temperature range			-55 to 150	°C

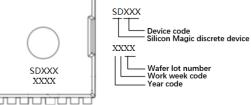




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2. Thermal resistance ratings

Thermal resistance ratings					
Parameter	Symbol	Max.	Unit		
Thermal resistance, junction-to-case	Steady state	Rejc	0.75	- °C/W	
Thermal resistance, junction-to-ambient (4)	Steady state	Reja	40		

3. Electrical Characteristics

Electrical characteristics ($T_J = 25^{\circ}$ unless otherwise noted)							
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit	
Static parameter							
Drain to source breakdown voltage	V(BR)DSS	$V_{GS} = 0 V$, $I_D = 1 mA$	40			V	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0	1.6	2.2	V	
Gate-body leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			±100	nA	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	2		1	μA	
Desis	P	V _{GS} = 10 V, I _D = 90 A	5	0.91	1.1		
Drain-source on-resistance	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 45 A		1.3	1.65	mΩ	
Forward transconductance ⁽⁵⁾	9 _{fs}	$V_{DS} = 5 \text{ V}, I_{D} = 90 \text{ A}$		350		S	
Gate resistance	Rg	f = 1 MHz		3		Ω	
Dynamic ⁽⁵⁾	-						
Total gate charge	Q_g	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 45 \text{ A}, \text{ V}_{GS} = 4.5 \text{ V}$		42			
Total gate charge	Q_g			86		nC	
Gate-source charge	Q_gs	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 90 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$		22		ne	
Gate-drain charge	Q_{gd}			16			
Turn-on delay time	t _{d(on)}			26			
Rise time	tr	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 90 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$		102]	
Turn-off delay time	t _{d(off)}	R _{GEN} = 4.7 Ω		111		ns	
Fall time	tr			37]	
Input capacitance	C _{iss}			5880			
Output capacitance	C _{oss}	$V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz$		2380	þ.	pF	
Reverse transfer capacitance	C _{rss}			90			
Reverse Diode Characteristics ⁽⁵⁾							
Diode forward voltage	V_{SD}	$V_{GS} = 0 V, I_F = 90 A$		0.8	1.1	V	
Reverse recovery time	trr	$V_{\rm ex} = 20 V_{\rm e} = 00 A_{\rm e} dV_{\rm e} = 400 A_{\rm e}$		66		ns	
Reverse recovery charge	Qrr	V _{DS} = 20 V, I _F = 90 A, di/dt = 100 A/µs		63		nC	

Notes

(1) Limited by package.

(2) Pulse width limited by maximum junction temperature.

(3) $V_{DS} = 20 V$, $V_{GS} = 10 V$, L = 0.3 mH.

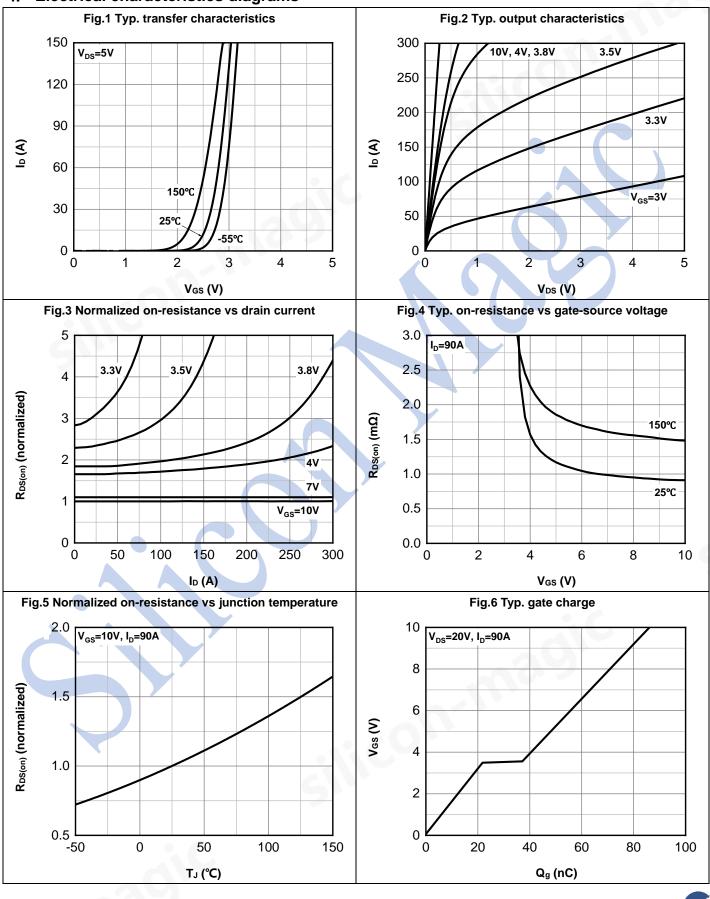
(4) $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5x1.5 in. board of FR-4 material.

(5) Guaranteed by design, not subject to production testing.





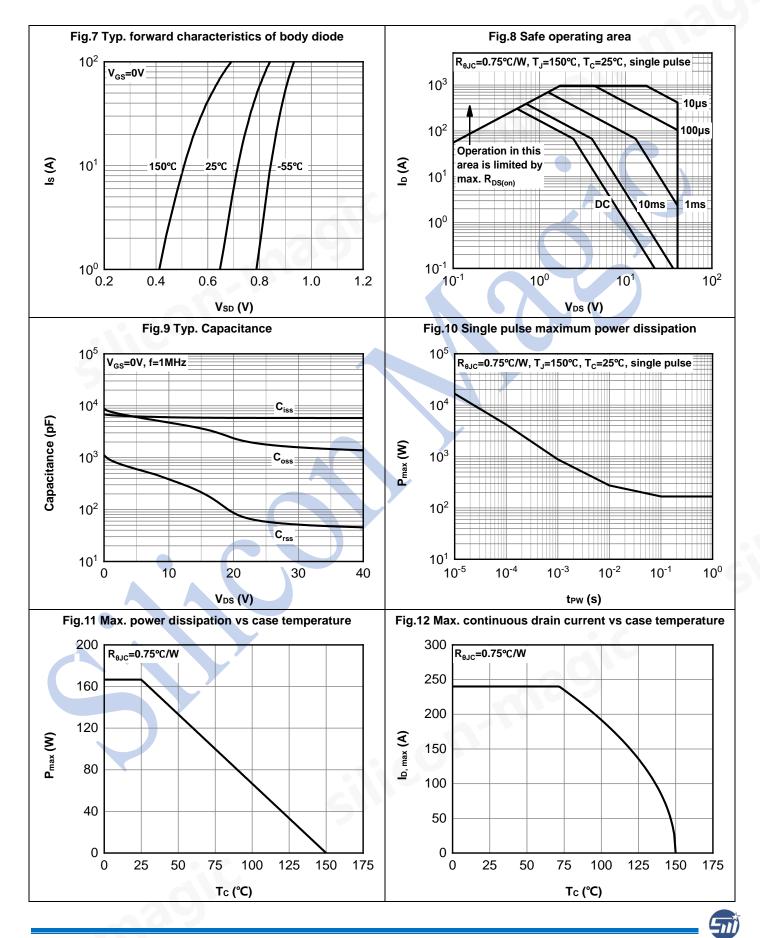
4. Electrical characteristics diagrams



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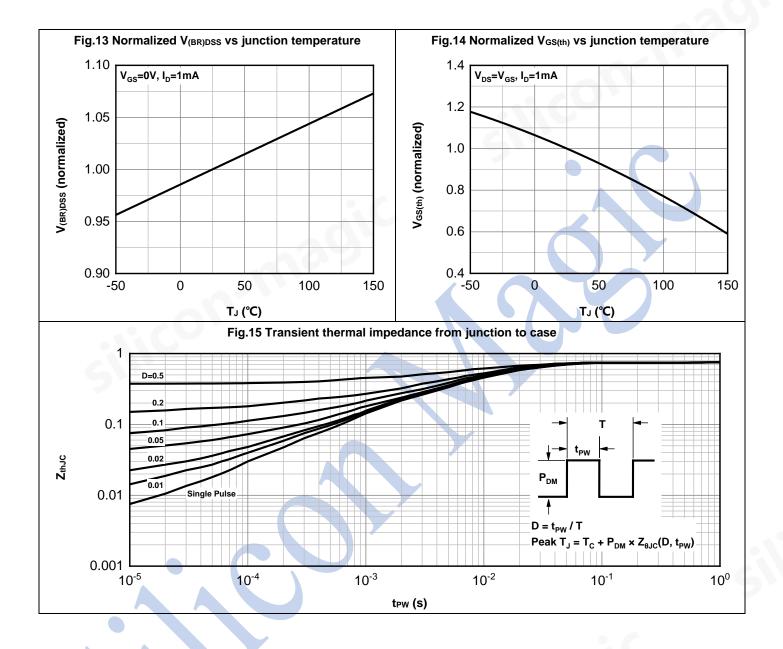
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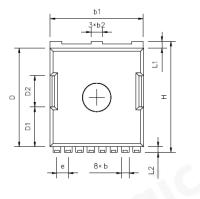


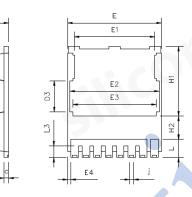


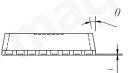




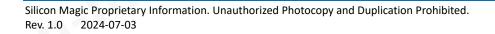
5. Package outline dimensions







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Dim		Millimeters		
Dim	Min	Nom	Max	
А	2.20	·	2.40	
b	0.70	-	0.90	
b1	9.70	-	9.90	
b2		1.20 REF		
С	0.40	-	0.60	
D	10.28	-	10.48	
D1	4.08	-	4.28	
D2	3.20	-	3.40	
D3	3.16	-	3.36	
E	9.80	-	10.00	
E1	8.40	-	8.60	
E2	9.30	-	9.50	
E3		8.80 REF		
E4	0.25	-	0.45	
е		1.20 BASIC		
Н	11.58	-	11.78	0.7
H1	7.23	-	7.43	
H2		2.45 REF		
i	0.10		-	
j		0.45 REF		
L	1.60	-	2.10	
L1	0.60	-	0.80	
L2	0.50	-	0.70	
L3	1.05	-	1.30	
θ		10° REF		



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